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Metal-insulator transitions in TiO₂/VO₂ superlattices

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We have fabricated a series of superlattices composed of $V_{1-x}W_xO_2$ (x=0 or 0.08 with 1+2x d electron per V atom) and TiO₂ (no d electron) to investigate the interface and carrier-confinement effects of the metalinsulator phenomena of VO_2 . This study was also motivated by the prediction of a half-metallic state with a semi-Dirac point at the TiO₂/VO₂ interface [V. Pardo and W. E. Pickett, Phys. Rev. Lett. 102, 166803 (2009)]. The growth conditions of the superlattices were optimized so that we could reproduce the known electronic states for the constituent compounds in case of the single-layer films, namely, VO₂ exhibiting a paramagnetic metal to spin-singlet insulator transition at around room temperature, $V_{0.92}W_{0.08}O_2$ (W:VO₂) being metallic down to the lowest temperature, and TiO₂ being a wide-gap band insulator. We found no metallic ground state in these superlattices in contradiction with the theoretical prediction. The TiO_2/VO_2 superlattices always show a resistive transition, corresponding to the metal-insulator transition in the VO₂ single layer, at around 300 K for the VO₂-layer thickness varying from 15 monolayers (ML) down to 3 ML. The resistive transition is accompanied with the structural change, consistent with the V-V dimerization in VO₂ along c axis, suggesting the robust spin-singlet bond formation as well as the dimeric lattice distortion persistent even at the TiO_2/VO_2 interface. In the case of TiO_2/W : VO₂ superlattices, the insulating ground state revives while the metalinsulator transition temperature decreases from 230 to 95 K as the W:VO₂ thickness is increased from 10 to 40 ML. These results indicate the persistent competition between the spin-singlet bond formation and the kinetic energy of correlated electrons regulated by the W:VO₂ thickness.

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I. INTRODUCTION

 VO_2 shows a $3d^1$ electron configuration and undergoes a metal-insulator transition at around 340 K, accompanied by a structural change from a high-temperature rutile (tetragonal) to a low-temperature monoclinic form.¹ Dimerization of V ions occurs in the latter with a tiling of the V-V bond from caxis. It makes 3d electrons localized on V sites forming spin singlet.² The magnetic susceptibility changes from paramagnetic to nonmagnetic upon the transition. VO_2 has recently been of particular interest for possible device application due to the fact that the transition occurs above room temperature with a huge jump in resistivity. Field-effect devices³ and photoinduced switches⁴ have been demonstrated with using VO₂ as the active layers. The metal-insulator phenomena in VO₂ can be controlled by electron doping in epitaxial $V_{1-x}W_xO_2$ thin films which can reach a metallic ground state at around x = 0.08 (W:VO₂).⁵

Recently, Pardo and Pickett suggested by the densityfunctional theory that a half-metallic VO₂ slab can be realized by confining VO₂ with insulating TiO₂ layers, where a semi-Dirac-point Fermi surface emerges in $(TiO_2)_m/(VO_2)_n$ superlattices at m=5 and $n=3.^6$ TiO₂ is a band insulator with $3d^0$ configuration and has a band gap of about 3.0 eV. As a consequence of quantum confinement of the *d* electrons in the VO₂ layers along *c* axis, a collective structural dimerization along the *c* axis is predicted to be suppressed and thereby the VO₂ layer to remain in the metallic state. The metal-insulator transition is predicted to occur through a semi-Dirac-point phase between n=3 and 4, which will not be accompanied by any structural changes. The banddispersion crossing occurs at a single point in momentum (k) space and the electrons behave as massless along the zone diagonal direction in k space and massive along the perpendicular direction. Such a semi-Dirac point is not destroyed with spin-orbital coupling. A single VO₂/TiO₂ interface has been previously investigated and no metallic state was observed.⁷ However, superlattice structures have not yet been constructed so far. In order to examine the theoretical prediction, the layer thicknesses of VO₂ and TiO₂ have to be controlled in an atomic scale.

While partly motivated by the theoretical prediction on the exotic half-metallic state, we have also intended to explore possible novel phenomena of the TiO₂/VO₂ superlattice systems related to the metal-insulator transitions coupled with the lattice-structural transition. The superlattices have seldom been examined for binary-oxide rutile structures whereas high-quality interfaces and superlattice structures have been well developed in ternary perovskite-type oxides.⁸ Examples of d^1/d^0 superlattices are LaTiO₃/SrTiO₃ and SrVO₃/SrTiO₃. When a Mott insulator LaTiO₃ is sandwiched by a band-insulator SrTiO₃ with chemically abrupt interfaces, the film shows a metallic behavior, indicating charge penetration from LaTiO₃ to SrTiO₃.⁹ The conducting interfaces between the two insulators were confirmed by photoemission study¹⁰ and optical spectroscopy.¹¹ The exotic metallic behavior at this interface has also been theoretically studied.¹² As another example, when metallic SrVO₃ is con-



FIG. 1. (Color online) Schematic view of (a) VO₂ structure and (b) (001)-oriented $TiO_2/VO_2/TiO_2$ structure, where the thickness of the VO₂ layer is 3 ML.

fined with $SrTiO_3$, a metal-insulator transition takes place depending on the $SrVO_3$ thickness.^{13,14} At a single $SrVO_3/SrTiO_3$ interface, a pseudogap starts to be formed at Fermi energy with decreasing $SrVO_3$ layer thickness, which is interpreted in terms of the crossover from three to two dimensions.¹⁵

One of the differences of rutile superlattices from those of perovskite is the cation-cation distance. In both cases, transition-metal ions form octahedra with oxygen ions. In perovskite, the cation-cation distance along c axis is about 0.39 nm due to corner sharing of octahedra whereas those in rutile are about 0.29 nm as depicted in Fig. 1(a) due to edge sharing. Moreover, the edge-sharing octahedra forms onedimensional chain along c axis and the overlap of wave function within *ab* plain is expected to be much smaller than that of perovskite. Therefore, the interface effects of rutile will be even more significant than those of perovskite due to the difference in the balance of electron-correlation energy and kinetic energy of electrons. Figure 1(b) displays three unit cells of VO₂ between TiO₂ slabs. The collective V-V dimerization in VO_2 is expected to be suppressed by the insertion of TiO_2 layers in the (001)-oriented superlattices.

In this work, we constructed $\text{TiO}_2/\text{V}_{1-x}W_x\text{O}_2$ (x=0 or 0.08) superlattices on TiO_2 (001) substrates. The effect of quantum confinement was examined in nondoped and electron-doped VO_2 layers with TiO_2 layers as the intervening barrier. For the both superlattices, the metal-insulator transition is so robust that no metallic ground state is realized. However, different features were found between the TiO_2/VO_2 and $\text{TiO}_2/\text{W}:\text{VO}_2$ superlattices, in particular, in the VO_2 or $\text{W}:\text{VO}_2$ thickness dependence on the metal-insulator transition temperature (T_{MI}). The results are argued comprehensively in terms of the robust spin-singlet formation causing the lattice dimerization that competes with the kinetic energy of correlated electrons in the VO_2 (or $\text{W}:\text{VO}_2$) layer.

II. TiO₂/VO₂ SUPERLATTICES

A. Growth optimization of individual films

Although the growth conditions of individual compounds have been well established, we have to fabricate both con-



FIG. 2. (Color online) Electrical resistivity of VO₂ (solid lines) and TiO₂ (a dashed line) single (non-superlattice)-layer films grown on TiO₂ (001) substrates at different oxygen pressures. The growth temperature was kept at 350 °C. The conductivity of TiO₂ films can be eliminated with annealing at 350 °C in an oxygen pressure of 1 Torr for 1 h (not shown). The annealing can compensate oxygen vacancies in VO₂ as well as in TiO₂ layers. The annealed VO₂ film grown at an oxygen pressure of 3 mTorr shows a clear resistivity jump at $T_{\rm MI}$, which is comparable to that grown at a high oxygen pressure of 10 mTorr. The film thickness of VO₂ is about 10 nm.

stituent layers with desired physical properties under the same condition which can be applied for the fabrication of superlattices. We first explored such a growth condition; the TiO_2 and VO_2 thin films were grown, respectively, on (001) surfaces of TiO₂ single-crystal substrates (purchased from Shinkosha Co., Ltd.) by a pulsed laser deposition method. The substrate temperature and the oxygen pressure were kept at 350 °C and at 3-10 mTorr, respectively, during the deposition. Substrate temperature above 400 °C resulted in a considerable interdiffusion of V and Ti ions across the interfaces, which has to be minimized to construct a chemically sharp interface. Details of the fabrication procedure for VO₂ epitaxial film on TiO₂ substrate were described elsewhere.⁵ Resistivity was measured with a conventional four-probe method employing Au/Ti double-layer electrodes deposited by electron-beam evaporation through a stencil mask. Transport properties were examined with physical property measurement system (PPMS; Quantum Design) and magnetic properties were investigated with magnetic property measurement system (MPMS; Quantum Design). X-ray diffraction (XRD) was measured at room temperature unless mentioned specifically.

We found that TiO_2 films have to be grown well below 10 mTorr especially at such a low substrate temperature in order to realize a flat surface and a high crystallinity. The TiO_2 film deposited at an oxygen pressure of 10 mTorr was amorphous. Temperature dependence of resistivity for a TiO_2 homoepitaxial film grown at 3 mTorr is shown in Fig. 2. Due to oxygen vacancies generated during the growth under such a low oxygen pressure, the TiO_2 film showed a metallic conductivity. Annealing procedure at 350 °C in an oxygen pressure of 1 Torr for 1 h after the deposition was found to eliminate the conductivity by compensating oxygen vacancies in the film (not shown).

Figure 2 also depicts resistivity data for a 10-nm-thick VO₂ film fabricated on TiO₂ (001) under various oxygen pressures. The film grown at an oxygen pressure of 10 mTorr exhibited a well-defined metal-insulator transition with a hysteresis as desired. However, this condition is not compatible with that for growing insulating TiO₂ film. When oxygen pressure was reduced to 3 mTorr, the metal-insulator transition was almost suppressed due to oxygen vacancies, which is consistent with a previous report.¹⁶ The annealing employed for the TiO₂ film was also effective for the VO₂ film to recover the desired metal-insulator transition as shown in Fig. 2.

B. Structure and properties of TiO₂/VO₂ superlattices

According to the optimized recipe described in the previous section, all the TiO₂/VO₂ superlattices were fabricated on TiO_2 (001) substrates; namely, at a substrate temperature of 350 °C and an oxygen pressure of 3 mTorr followed by an annealing procedure under an oxygen pressure of 1 Torr for 1 h. In this growth condition, both TiO₂ and VO₂ layers show their expected properties. The layer thicknesses of constituent layers in superlattices were regulated by the deposition duration. The thickness of TiO2 was maintained at 5 monolayers (ML) so as to mimic the theoretically predicted situation.⁶ The total thickness of the superlattices was set at around 60 nm. The XRD patterns for a series of $(TiO_2)_5/(VO_2)_n$ superlattices are shown in Fig. 3(a). The peaks assignable to 002 reflections (arrows) are clearly seen, thereby confirming the (001)-oriented epitaxial growth of TiO_2/VO_2 superlattices. The average lattice constant of the superlattices systematically decreases with increasing thickness of the VO₂ layer. The *c*-axis lattice constants of TiO₂, VO₂ (rutile), and VO₂ (monoclinic) thin films pseudomorphically grown on TiO₂ (001) are 0.296 nm, 0.283 nm, and 0.285 nm, respectively. X-ray reciprocal space mapping data indicates that the $(TiO_2)_5/(VO_2)_n$ superlattices have a pseudomorphic structure with identical in-place lattice constant (a=0.459 nm). Tiny lattice-relaxation behavior starts to be observed with increasing *n* above 5, e.g., in the [5/15]superlattice. Figure 3(b) shows the temperature dependence of the average lattice constant of the [5/10] and [5/15] superlattices above room temperature. The lattice constants decrease with increasing temperature around 300-320 K due to the structural change in VO2 from low-temperature monoclinic to high-temperature rutile. The inset shows XRD patterns around 002 diffraction peak of the [5/10] superlattice at various temperatures from 300 to 321 K. These results denote that the majority of the VO₂ layer in the superlattices is monoclinic at room temperature (300 K) although the phase transition seems to be completed at lower temperatures and not yet at 300 K. The structure difference and coexistence of TiO₂ (rutile) and VO₂ (monoclinic) resulted in the degraded XRD patterns in Fig. 3(a). In fact, the sharp XRD patterns with well-defined Laue fringes were observed for $TiO_2/W:VO_2$ superlattices with both rutile structures at room temperature (see Sec. III B and Fig. 5).

Figure 4 presents temperature dependence of resistivity for the TiO_2/VO_2 superlattices with varying VO_2 layer



FIG. 3. (Color online) (a) XRD patterns of the $(TiO_2)_5/(VO_2)_n$ (n=3, 4, 5, 10, and 15) superlattices around TiO_2 002 diffraction peak. The arrows indicate principal diffractions of superlattices that reflect the average lattice constant. The satellite peaks reflecting the periodicity is denoted by +1 and -1. The designed periodicity is denoted by [m/n] and the repetition is denoted by r. (b) Temperature dependence of the c-axis average lattice constants of the [5/10] and [5/15] superlattices. The lattice shrinks around 300–320 K with increasing temperature from room temperature, corresponding to a structural transition of VO₂. The inset shows XRD patterns around 002 diffraction peak of the [5/10] superlattice at various temperatures.

thickness. All the superlattices show thermal hystereses in resistivity at around 310 K, indicating a structural transition of VO₂ layers. This is consistent with the result of the structural characterization. Hereafter, we refer this structural transition temperature as $T_{\rm MI}$, even though not fully metallic above $T_{\rm MI}$ in these superlattices. With increasing the VO₂-layer thickness to 10 ML, the resistivity decreases and its jump at $T_{\rm MI}$ becomes sharper; namely, the thermal behavior approaches to that of a single-layer VO₂ film. The [5/15] film exhibits a broader transition, suggesting an effect of microcracks which have been previously reported in VO₂ films.¹⁷ There, a number of lines representing cracks were observed in atomic force microscope images above the criti-



FIG. 4. (Color online) Temperature dependence of resistivity for the $(TiO_2)_5/(VO_2)_n$ superlattices. The data (a broken line) of a single-layer VO₂ film are also depicted for comparison. Resistivity change at the transition becomes more pronounced with increasing the VO₂ layer thickness.

cal thickness of 15 nm (50 ML). For these superlattices, no metallic ground states were observed at low temperatures, although predicted theoretically for $n \ge 3.^6$ Furthermore, no ferromagnetic signal was detected. The apparent difference from the theoretical prediction is the extremely robust V-V dimerization which can survive in reality even when the VO₂ layer is as thin as 3 ML. No appreciable shift of $T_{\rm MI}$ indicates that the VO₂ characteristics are not affected by the insertion of TiO₂ slabs. Even the [5/3] superlattice shows a small resistivity jump with a thermal hysteresis at $T_{\rm MI}$, indicating a persistent structural change; this is again in contrast to the theoretical prediction that the metal-insulator transition will not occur with any structural changes.

III. TiO₂/W:VO₂ SUPERLATTICES

Since the metallic ground state was not observed for the TiO_2/VO_2 superlattices, the inherently metallic W:VO₂ layer was alternatively utilized as the component layer for the superlattice. It has recently been clarified for the single-layer V_{1-x}W_xO₂ that V-V dimerization is systematically destabilized with W doping and that the T_{MI} is monotonically reduced with W concentration (*x*) up to 8% substitution.⁵ We chose the composition of V_{0.92}W_{0.08}O₂ (*x*=0.08) that shows a metallic behavior in a whole temperature region below 400 K in case of the single-layer film.

A. Growth optimization of individual films

The crystallinity of W:VO₂ films grown at an oxygen pressure of 3 mTorr was as good as that of the films grown under a higher pressure of 20 mTorr. However, the low-pressure-grown films show distinct metal-insulator transition at around 100 K (not shown) while the films grown at an oxygen pressure of 20 mTorr exhibit a metallic ground state.⁵ This is perhaps because the W ion as the donor is not fully oxidized in such a low pressure. Therefore, we employed an ozone (O₃) atmosphere (introduced directly from an ozonizer) for growing W:VO₂ films with keeping the substrate



FIG. 5. (Color online) XRD patterns of the $V_{0.92}W_{0.08}O_2$ (W:VO₂) single-layer film and the $(TiO_2)_5/(W:VO_2)_n$ (n=15, 20, and 40) superlattices around TiO₂ 002 diffraction peak. The designed periodicity is denoted by [m/n] and the repetition is denoted by r. Clear Laue fringes and superlattice satellite peaks are seen because both TiO₂ and W:VO₂ have rutile (tetragonal) structure at room temperature and show the atomically sharp interfaces.

temperature at 350 °C. The W:VO₂ film grown at 3 mTorr of O₂/O₃ showed a comparable crystallinity with that deposited at 20 mTorr oxygen pressure. The O₂/O₃ environment is thus turned out not to be harmful to the epitaxial growth of TiO₂ films. Therefore, TiO₂/W:VO₂ superlattices were fabricated on TiO₂ (001) substrates at a temperature of 350 °C and O₂/O₃ pressure of 3 mTorr followed by an annealing procedure under an oxygen pressure of 1 Torr for 1 h. The total film thickness was set at 60–70 nm and the thickness of TiO₂ was kept at 5 ML as in the case of the TiO₂/VO₂ superlattices so as to facilitate the straightforward comparison of the both cases.

B. Structure and properties of TiO₂/W:VO₂ superlattices

Figure 5 shows the XRD patterns of a single-layer $W: VO_2 (V_{0.92}W_{0.08}O_2)$ film and $(TiO_2)_5/(W: VO_2)_n$ (n=15, 20, and 40) superlattices. The single-layer film was fabricated under the optimized condition as described in the previous section. The *c*-axis lattice constant of $V_{0.92}W_{0.08}O_2$ is 0.287 nm. Clear Laue fringes and superlattice satellite peaks are seen, indicating both TiO2 and W:VO2 are hightemperature rutile (tetragonal) phases at room temperature in contrast to TiO₂/VO₂ superlattices. From these diffraction peaks, the film thickness was deduced to be 60-70 nm and the structures of superlattices were confirmed to be as designed. Pseudomorphic growth was confirmed for the all superlattices without lattice relaxation. The sharp interfaces within the superlattice were also confirmed (not shown in figures) by the secondary ion mass spectroscopy, although its resolution was limited to 2-3 nm.

Temperature dependence of resistivity for the $(TiO_2)_5/(W:VO_2)_n$ superlattices is presented in Fig. 6. Although the resistivity is decreased as the W:VO₂ layer thick-



FIG. 6. (Color online) Temperature dependence of resistivity for the $(TiO_2)_5/(W:VO_2)_n$ superlattices. The data for a single-layer $W:VO_2$ film are also presented for comparison. All the superlattices show metal-insulator transitions at various temperatures in contrast to the metallic ground state of the single-layer film, indicating less itinerant characteristics due to confinement. The metal-insulator transition temperature, $T_{\rm MI}$, (open triangles) is determined as the inflection point of the temperature-resistivity curve.

ness is increased from n=5 to 40, the metal-insulator transition is persistently observed and the resistivity in a metallic temperature region is considerably higher than that of the single-layer $W: VO_2$ film. These results imply that the carrier dynamics in the W:VO₂ layer suffers from scattering at the interfaces as well as reduction in the bandwidth due to the two-dimensional confinement. Recently, Yoshimatsu et al. found a dimensional-crossover-driven metal-insulator transition in SrVO₃ on SrTiO₃ surface, a heterostructure composed of $3d^{1}/3d^{0}$ system.¹⁵ They found that at least 3 ML (1.2 nm) of SrVO₃ is necessary for a finite density of states at Fermi energy. The observed transition to the insulating ground state is ascribed to the reduction in the bandwidth. A similar scenario appears applicable to the present case, although the critical thickness seems to be much larger in the $W: VO_2/TiO_2$ system. The difference may be understood by considering that VO₂ with rutile structure has a larger bandwidth along c axis than in the ab plane and hence is more amenable to the electronic confinement along the c axis in the superlattices.

IV. PHASE DIAGRAM

Figure 7(a) presents the variation in $T_{\rm MI}$ with the thickness of VO₂ or W:VO₂ layers in the both series of superlattices. The transition temperature, $T_{\rm MI}$, is defined from resistivity (ρ) data as the inflection points in $d[\ln(\rho)]/d(1/T)$ versus temperature (T) plots. There can be seen no shift in $T_{\rm MI}$ for the TiO₂/VO₂ superlattices as mentioned above. The V-V dimerization in VO₂ is so robust against the confinement when the filling is kept as d^1 as in the present case. On the contrary, the $T_{\rm MI}$ for the TiO₂/W:VO₂ superlattices increases with reducing the W:VO₂ layer thickness. One of the possible origins for the $T_{\rm MI}$ shift is the charge transfer from W:VO₂ layer to TiO₂ layer across the interface. To check



FIG. 7. (Color online) (a) The metal-insulator transition temperatures ($T_{\rm MI}$) deduced from resistivity data are plotted as a function of layer thickness of VO₂ or W:VO₂. The layer thickness of TiO₂ is fixed at 5 ML. The $T_{\rm MI}$ of TiO₂/VO₂ superlattices (closed triangles) is nearly independent of VO₂ layer thickness whereas that of TiO₂/W:VO₂ (closed circles) critically increases as the W:VO₂ layer thickness is reduced. Those of single-layer VO₂ (open triangle) and W:VO₂ (open circle) are presented for comparison. Dashed lines are merely the guide to the eyes. (b) A metal-insulator phase diagram in $V_{1-x}W_xO_2$ ($0 \le x \le 0.095$) film (squares). The $T_{\rm MI}$ of the (TiO₂)₅/(W:VO₂)_n superlattices (circles) is plotted, assuming the excess *d* electron in the W:VO₂ layer is uniformly distributed over the whole superlattice.

this possibility, we plot the $T_{\rm MI}$ of superlattices [Fig. 7(b)] on the x vs $T_{\rm MI}$ phase diagram of $V_{1-x}W_xO_2$ (x<0.095) system,⁵ assuming the excess d electron (0.08×2 per V atom) is evenly distributed over the entire film. The deviation indicates that the $T_{\rm MI}$ shift cannot be solely explained by this simple scenario of charge transfer; electrons mainly localize in the constituent VO₂ layer due to the discontinuity of VO₂ conduction chain along c axis by the insertion of TiO₂ layers.

The VO₂ (or W:VO₂) layer thickness (*m* ML) dependence of the $T_{\rm MI}$ is quite different between the two cases of TiO₂/VO₂ and TiO₂/W:VO₂ superlattices. It is known that the lattice-structural transition of the VO₂ layers at $T_{\rm MI}$ is dominated by the local spin-singlet (valence-bond solid; VBS) formation originating from the strongly correlated t_{2g} electron with S=1/2.¹⁸ The important implication from the

minimal m dependence of $T_{\rm MI}$ for the TiO₂/VO₂ superlattices is that such dimeric lattice distortion is of short range in nature, yet the lattice strain filed may survive across the interface. When the band filling of VO₂ is changed, by contrast, the metallic state tends to be stabilized even in the electron-confined superlattices. Nevertheless, the kinetic energy of the correlated electrons is still too small to realize the true metallic ground state for the investigated superlattices $(m \le 40)$ and the W: VO₂ layers are readily amenable to the lattice-dimeric spin-singlet formation at low temperatures; the excess carriers in the dimerized lattice below $T_{\rm MI}$ seem to be well localized perhaps due to the self-trapping process. Then, the competition between the electron kinetic energy controlled by the $W: VO_2$ thickness (m) and the spin-singlet (VBS) formation may produce the steep *m* dependence of $T_{\rm MI}$ as observed for the TiO₂/W:VO₂ superlattices. The contradiction to the theoretically predicted half-metallic state in the TiO_2/VO_2 superlattices is thus ascribable to the stronger electron correlation leading to the local spin-singlet formation irrespective of deviations from half band filling or even number of m (VO₂ layer thickness) as well as to the stronger electron-lattice interaction producing the lattice strain field of longer range than originally anticipated.

V. CONCLUSIONS

We have fabricated rutile-type superlattices of TiO_2/VO_2 and $TiO_2/W:VO_2$. The metal-insulator transition near room temperature was persistently observed in the TiO_2/VO_2 superlattices. Unlike the theoretical prediction by Pardo and Pickett,⁶ the metal-insulator transition is accompanied with the structural change in VO_2 even when the layer is as thin as 3 ML. The quantum confinement of VO₂ layer with TiO₂ slabs does not suppress the collective V-V dimerization. The $T_{\rm MI}$ of the TiO₂/VO₂ superlattices is independent of the VO₂ layer thickness. A half-metallic behavior as proposed⁶ was not observed. When we add electrons in VO₂ layers with employing $TiO_2/W:VO_2$ superlattices, the T_{MI} is reduced with the increase in the $W: VO_2$ layers thickness $(d_{W:VO_2})$ but the insulating phase cannot be diminished up to $d_{W:VO_2} = 40$ ML, resulting in no metallic ground states. In this case, the steep $d_{W;VO_2}$ dependence of T_{MI} can be ascribed to the competition between the electron kinetic energy regulated by $d_{W:VO_2}$ and the spin-singlet formation. The observed robust lattice-structural transition in most of the superlattices thus arises from such a local electron-lattice interaction characteristic of this highly correlated electron (S=1/2) system as well as the possible long-range lattice strain field.

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